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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the Application of)	
RICHARD R. HENGST)	
Serial No.: 09/884,720)	Group Art Unit: 1763
Filed: June 19, 2001)	Examiner: Ram N. Kackar
For: APPARATUS AND METHOD OF)	(Our File No. 6096-01)
MAKING A SLIP FREE WAFER BOAT)	

Box **NON-FEE AMENDMENT**
ASSISTANT COMMISSIONER FOR PATENTS
Washington, D.C. 20231

RESPONSE TO OFFICE ACTION

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Dear Sir:

This is in response to the Office Action dated October 2, 2002 issued in the above-identified application. The time for response extends until January 2, 2003.